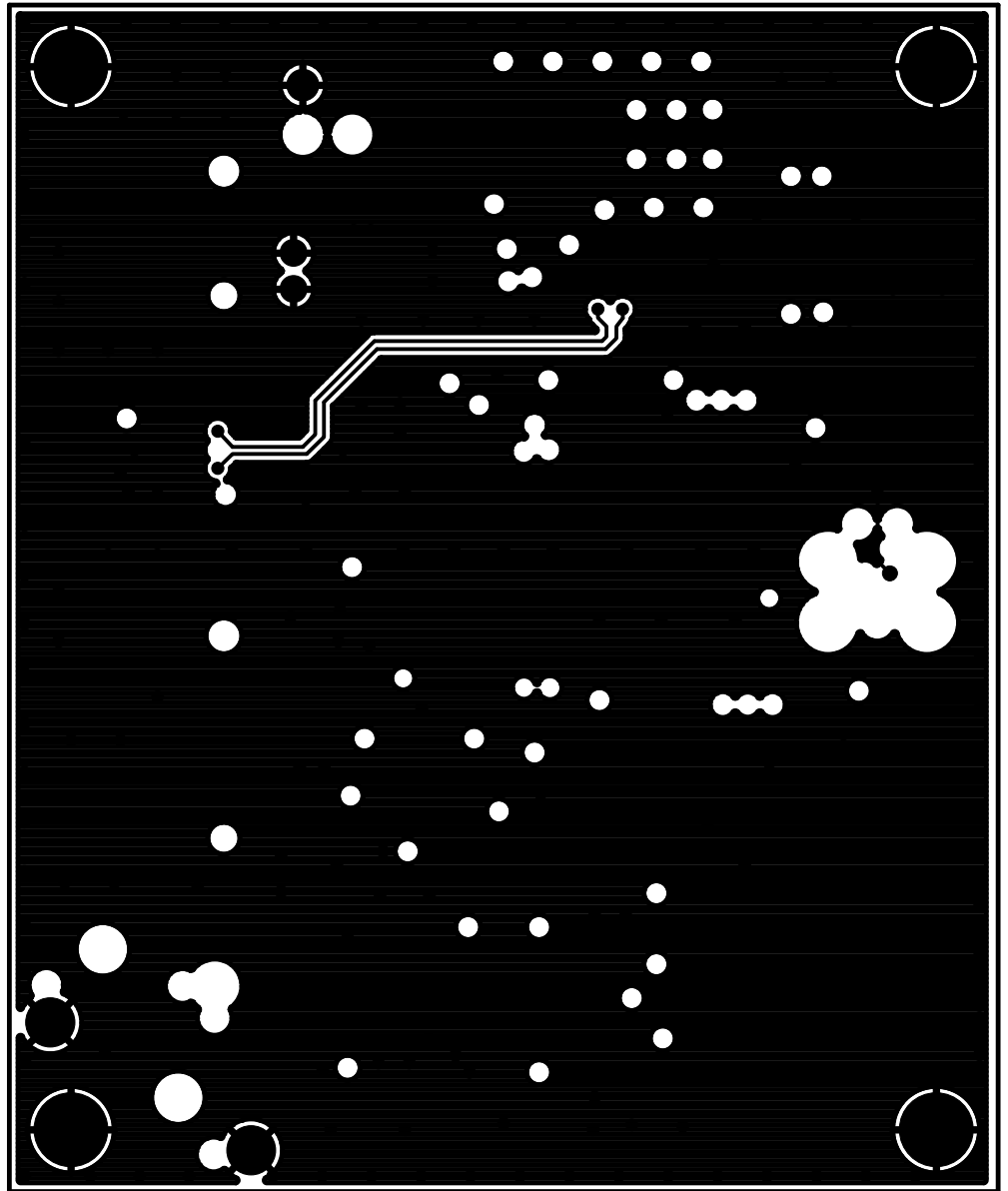


LAYER TOP

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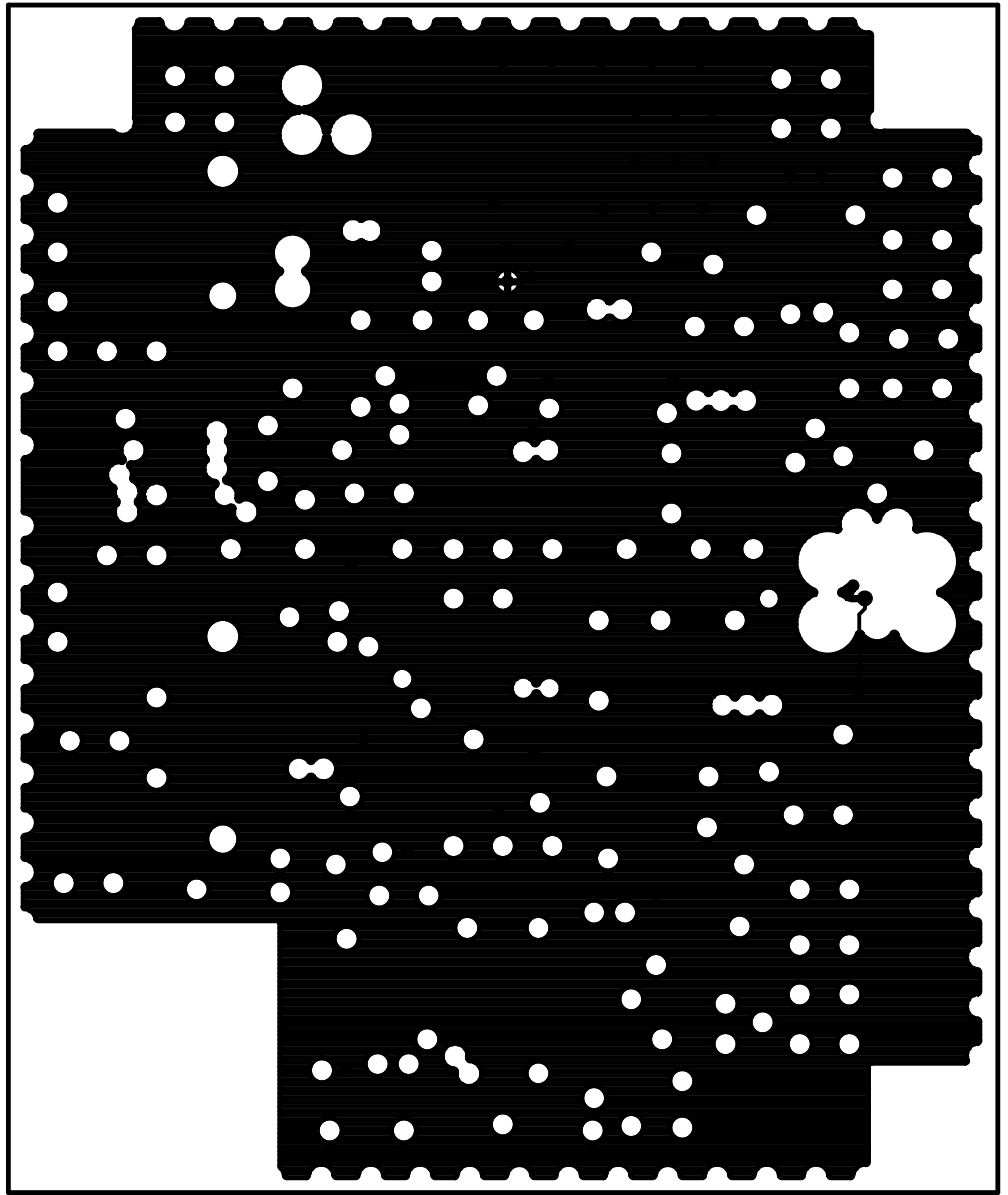




LAYER 2- GND

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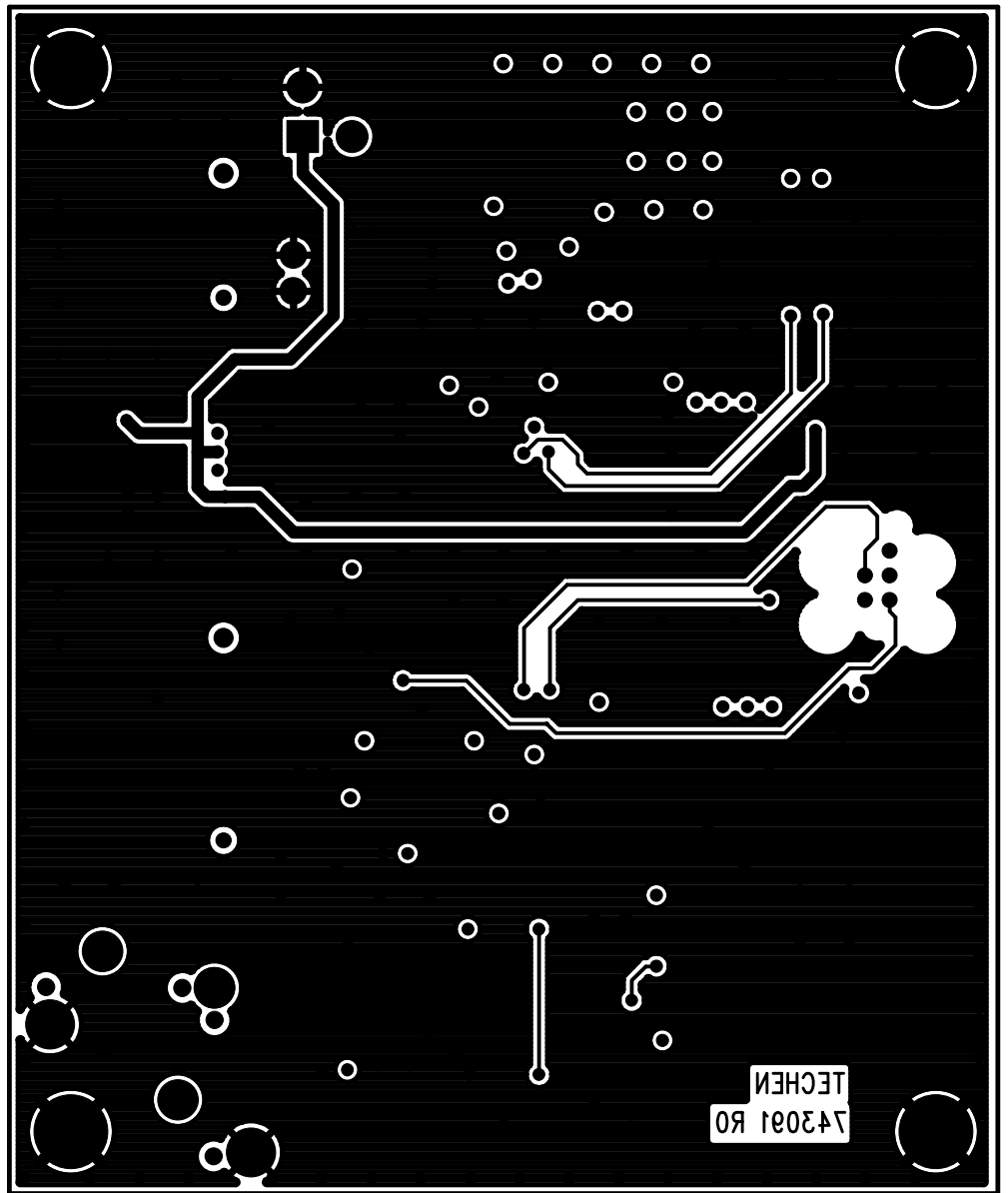




LAYER 3- PWR

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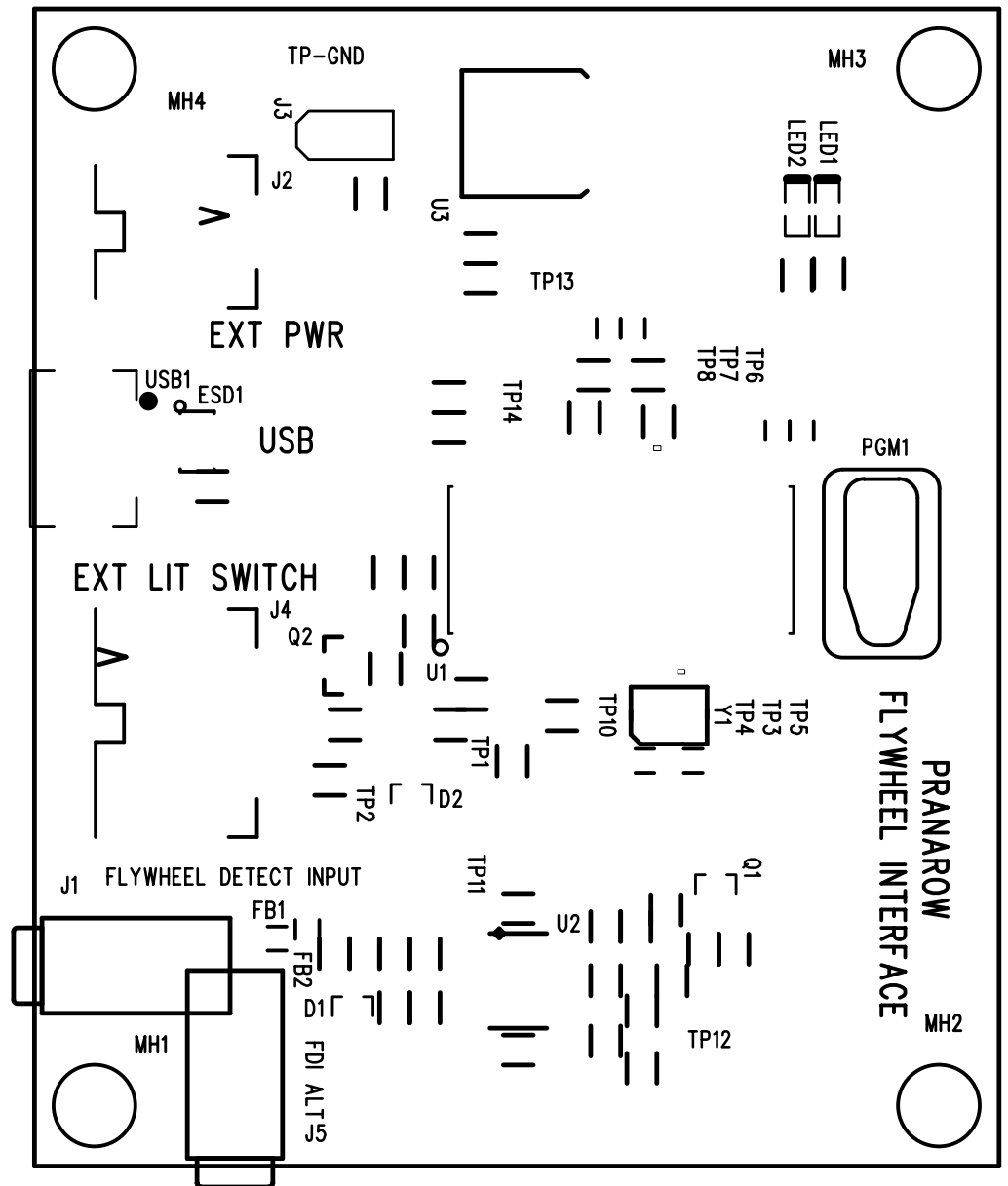




LAYER BOTTOM

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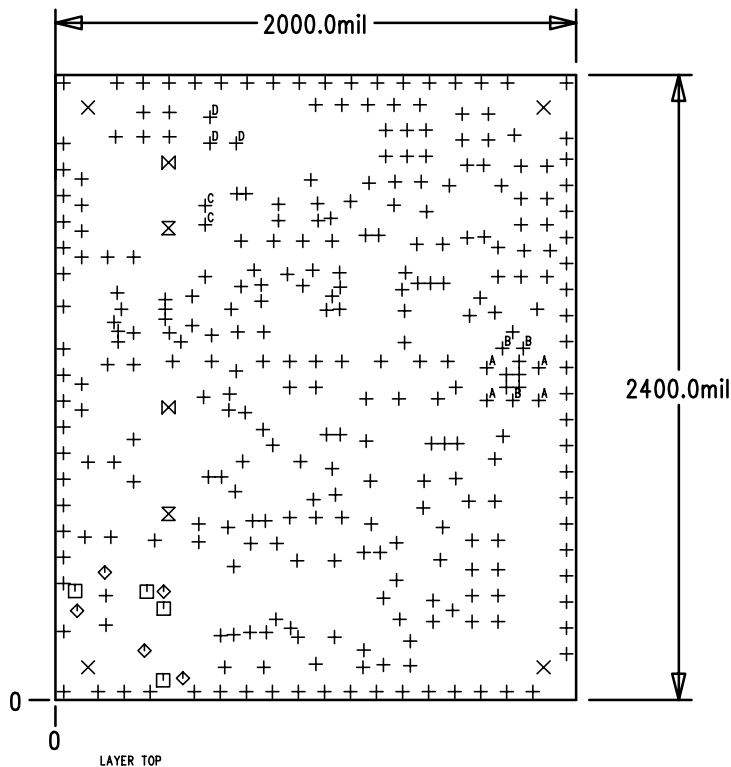




LAYER TOP  
SILKSCREEN TOP

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 MATERIAL- IPC-4101/126, 4 LAYER, SMOBC, SILKSCREEN WHITE LPI  
 BOARD THICKNESS: 0.031" +/- .0031"  
 CONDUCTIVE MATERIAL: 1.0 oz. Cu  
 FABRICATE PER IPC-6012 CLASS II  
 FINISH, SMOBC, PbSn HASL  
 SOLDERMASK GREEN, SILKSCREEN WHITE LPI

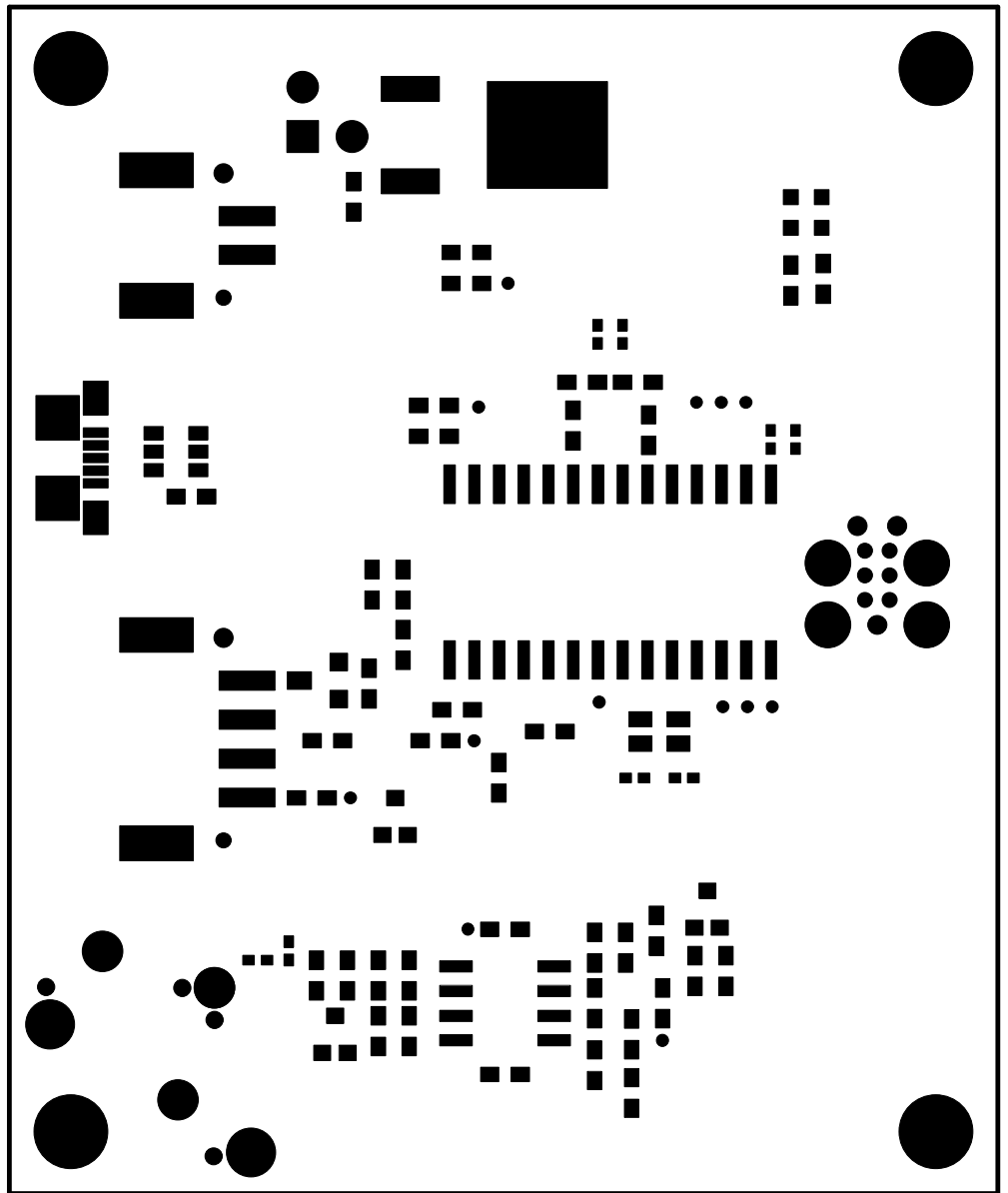
#### DRILL CHART UNITS (MILS)

SIZE	QTY	SYM	PLATED	TOL
12	295	+	YES	+/-3mils
125	4	X	YES	+/-3mils
35.43	4	□	NO	+/-3mils
55.12	5	◇	YES	+/-3mils
31.5	2	⊗	NO	+/-3mils
39.37	2	⊗	NO	+/-3mils
93.5	4	+ <sup>A</sup>	NO	+/-3mils
39.02	3	+ <sup>B</sup>	NO	+/-3mils
37	2	+ <sup>C</sup>	YES	+/-3mils
40	3	+ <sup>D</sup>	YES	+/-3mils

#### BOARD OVERALL THICKNESS- 0.031" +/- 0.0031"

LAYER 1 Cu- 1.0 OZ		DIEL THK - 0.008"
LAYER 2 Cu- 0.5 OZ		DIEL THK - 0.010, ADJUST FOR MFG
LAYER 3 Cu- 0.5 OZ		DIEL THK - 0.008"
LAYER 4 Cu- 1.0 OZ		

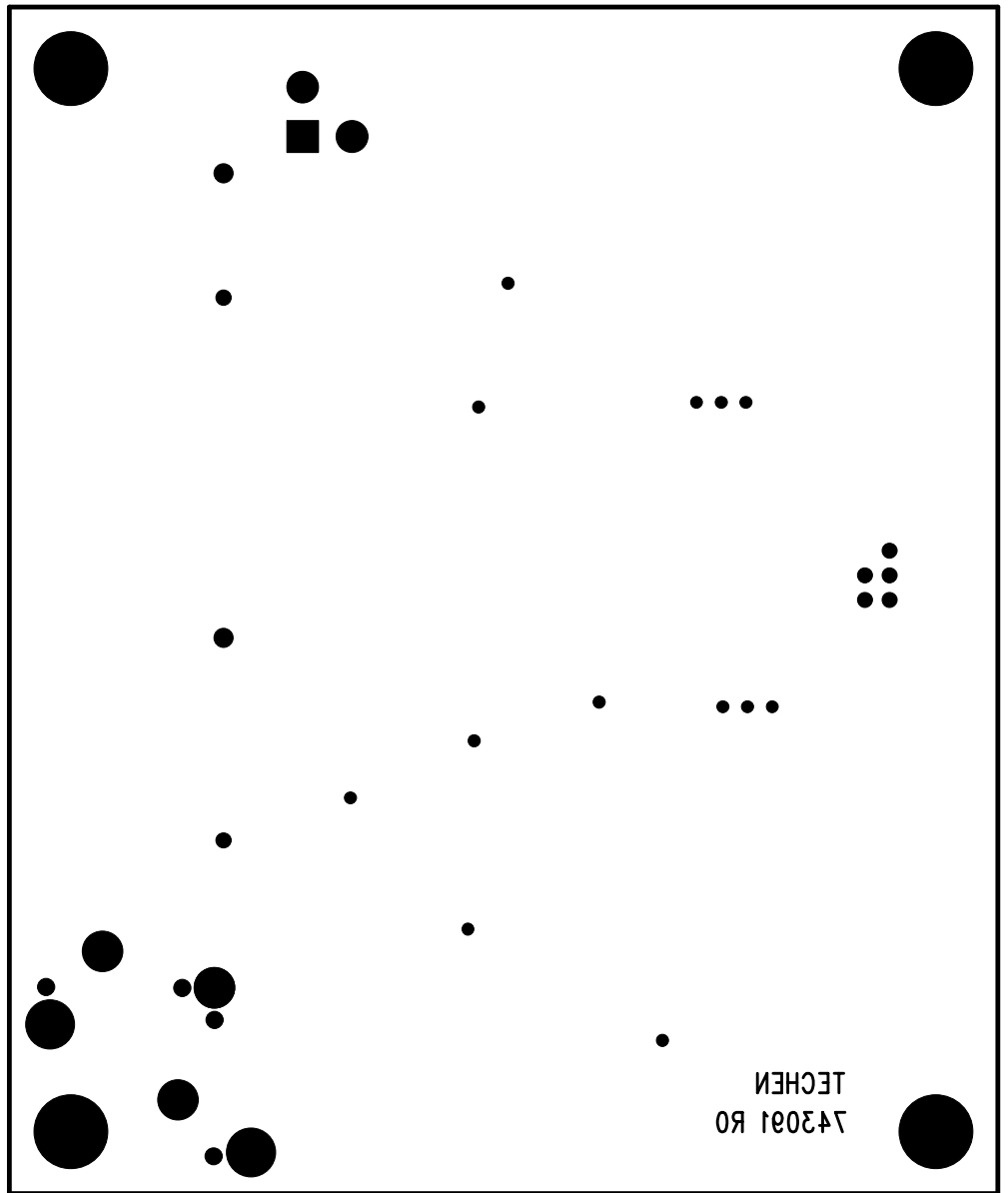




LAYER TOP  
SOLDER MASK TOP

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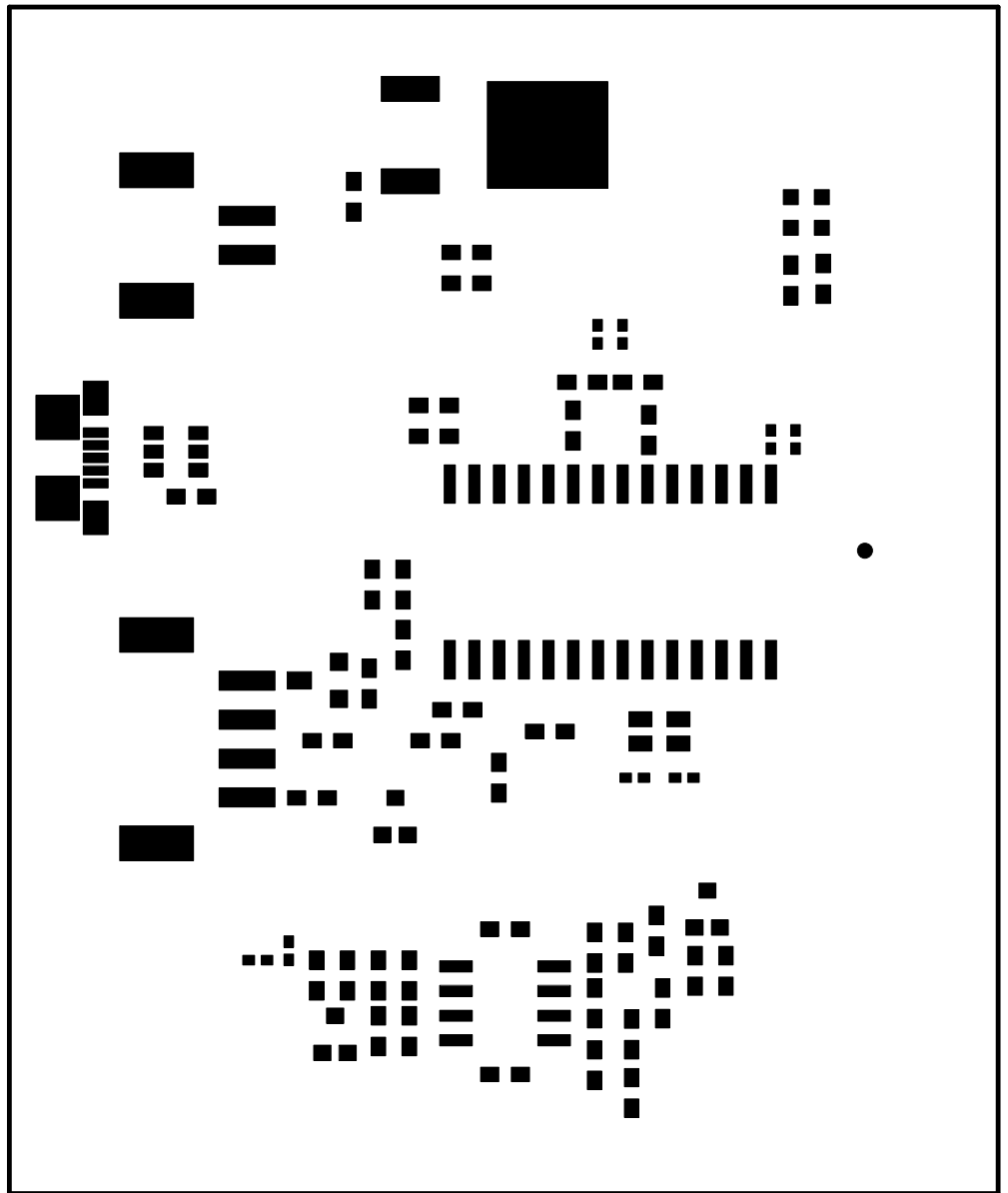


LAYER BOTTOM  
SOLDER MASK BOTTOM

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LAYER TOP  
PASTE MASK TOP

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